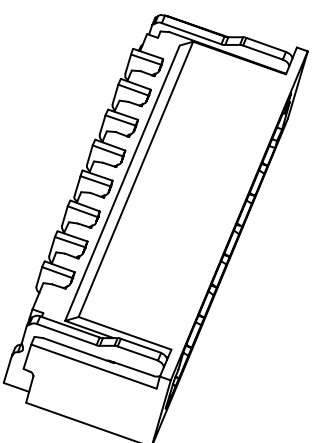


PCB Layout



Pin#	A	B	C
2	0.8	1.85	3.85
3	1.6	2.65	4.65
4	2.4	3.45	5.45
5	3.2	4.25	6.25
6	4	5.05	7.05
7	4.8	5.85	7.85
8	5.6	6.65	8.65
9	6.4	7.45	9.45
10	7.2	8.25	10.25
11	8	9.05	11.05
12	8.8	9.85	11.85
13	9.6	10.65	12.65
14	10.4	11.45	13.45
15	11.2	12.25	14.25
16	12	13.05	15.05
17	12.8	13.85	15.85
18	13.6	14.65	16.65
19	14.4	15.45	17.45
20	15.2	16.25	18.25
21	16	17.05	19.05
22	16.8	17.85	19.85

SPECIFICATION
 1. Material:
 Housing: HIGH-TEMP Plastic; UL94V-0,color: Natural.
 Contacts: Copper alloy.
 Solder tab: Copper alloy.
 2. Electrical Characteristics:
 Current rating: 0.5A(max).
 Voltage rating: 50V(max).
 Operating Temperature: -25C~+85C.
 Insulation resistance: 100M ohms min. at 500V DC
 Dielectric withstanding voltage: 500V AC/minute.
 Contact resistance: 30m ohms max.

UNITS: mm		CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE		PART NO. (INTENDED USE)		TITLE: WAFER 0.8MM XP 立册	
X. ±5°	0.X±0.25	CWF08XX172002		DWG NO. WAFER	
X. 1±2°	0.XX±0.2	APPD:		SCALE	
XX. ±1°	0.XXX±0.1	CHKD: Skila		SHEET	
		DR: Kitty		1 OF 1	
				REV	
				A	